

Plastic Mold Infrared LEDs

KED861M32

Characteristics

- Transparent epoxy mold
- High power:22mW
- High speed response:25ns rise time
- Direct modulation

Applications

- Available for wireless digital transmission
- Optical switches
- Optical encoders
- Optical instruments
- Automatic control apparatus

Chip Material

• GaAlAs

Package

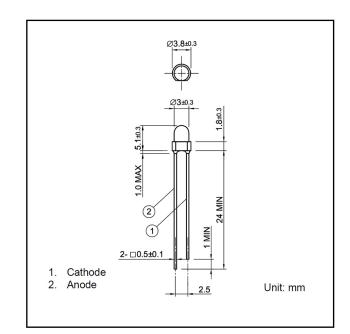
• MOLD

Diameter

• 3mm

Resin Type

• clear





Absolute Maximum Ratings

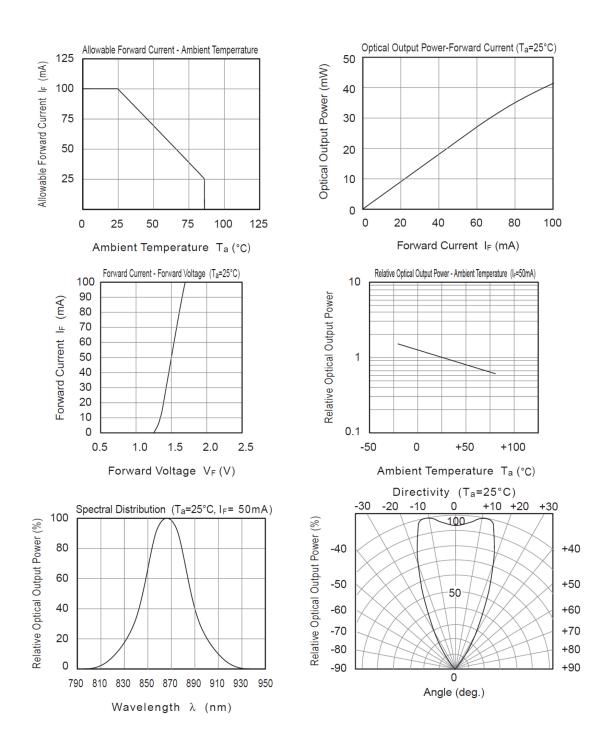
| Parameter | Symbol | Value | Unit | Conditions |
|-----------------------|------------------|-------------|------|------------------------------------|
| Reverse voltage | V _R | 5 | V | |
| | | | | |
| Forward current | I _F | 100 | mA | |
| | | | | - |
| Peak forward current | I _{FP} | 1 | А | Pulse width=100µs |
| | | | | Duty ratio=1% |
| Power dissipation | P _D | 150 | mW | |
| | | | | - |
| Operating temperature | T _{opr} | -30 to +85 | | Avoid dew condensation |
| Storage temperature | T _{stg} | -30 to +100 | | Avoid dew condensation |
| Soldering temperature | T _{sol} | 260 | | Soldering time less than 5 seconds |

Electrical and Optical characteristics

(Ta=25 unless otherwise noted)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions |
|----------------------|----------------|------|------|------|------|----------------------|
| Reverse Current | I _R | - | - | 10 | μA | V _R =5V |
| Forward voltage | V _F | - | 1.5 | 1.8 | V | I _F =50mA |
| | | | | | | |
| Optical output power | Po | - | 22 | - | mW | I _F =50mA |
| | | | | | | |
| Peak wavelength | р | - | 865 | - | nm | I _F =50mA |
| | | | | | | |
| Spectral width | | - | 40 | - | nm | I _F =50mA |
| | | | | | | |
| Half angle | 2 | - | 50 | - | deg. | I _F =50mA |
| | | | | | | |
| Rise time | tr | - | 25 | - | ns | I _F =50mA |
| Fall time | tf | - | 15 | - | ns | I _F =50mA |







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1724 Shimotsuboyama, Shimotsuke-shi, Tochigi 323-0194, Japan TEL:+81-285-39-7950 https://www.dexerials.jp/en/